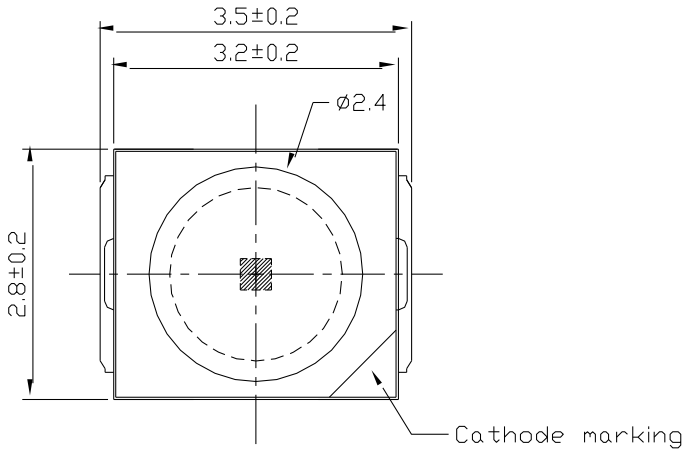
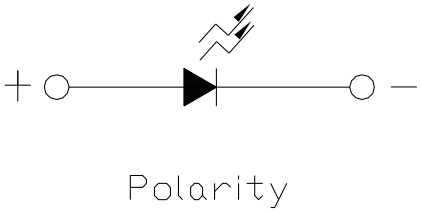
Technical Data Sheet -Preliminary

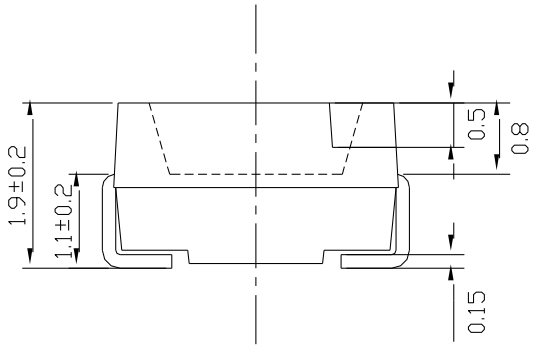
Top View LEDs

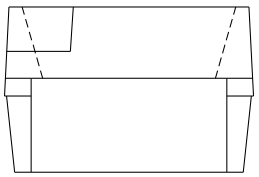
67-21/R6C-FS1U1B/2T

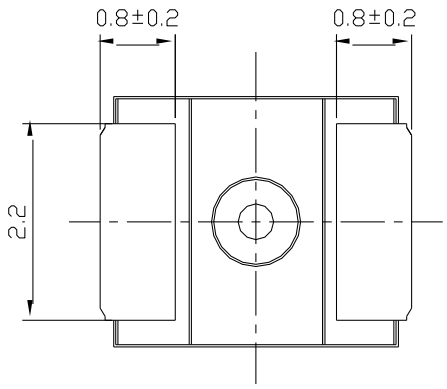
Package Dimensions

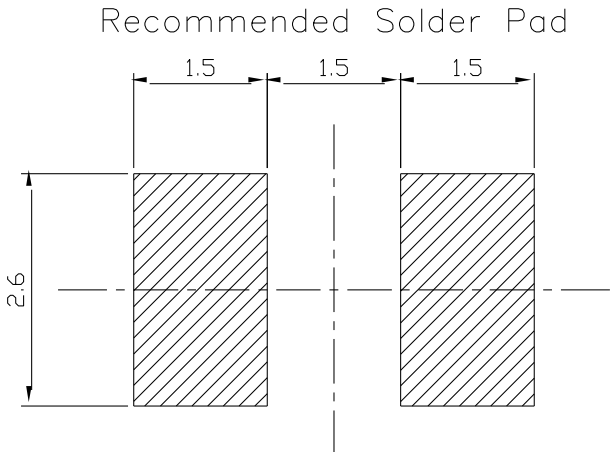












Note: The tolerances unless mentioned is ±0.1mm ;Unit = mm

Technical Data Sheet -Preliminary

Top View LEDs

67-21/R6C-FS1U1B/2T

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	50	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	100	mA
Power Dissipation	Pd	120	mW
Electrostatic Discharge(HBM)	ESD	2000	V
Operating Temperature	Topr	-40 ~ +85	℃
Storage Temperature	Tstg	-40 ~+90	℃
Soldering Temperature	Tsol	Reflow Soldering : 260 ℃ for 10 sec. Hand Soldering : 350 ℃ for 3 sec.	

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	180	-----	565	mcd	I_F=20mA
Viewing Angle	$2\theta_{1/2}$	-----	120	-----	deg	I_F=20mA
Peak Wavelength	λp	-----	632	-----	nm	I_F=20mA
Dominant Wavelength	λd	621	-----	631	nm	I_F=20mA
Spectrum Radiation Bandwidth	Δ λ	-----	20	-----	nm	I_F=20mA
Forward Voltage	V_F	1.75	-----	2.35	V	I_F=20mA
Reverse Current	I_R	-----	-----	10	μA	V_R=5V

Notes:

1.Tolerance of Luminous Intensity: ±11%
2.Tolerance of Dominant Wavelength: ±1nm
3.Tolerance of Forward Voltage: ±0.1V

Technical Data Sheet -Preliminary

Top View LEDs

67-21/R6C-FS1U1B/2T

Bin Rang of Luminous Intensity

Bin	Min	Max	Unit	Condition
S1	180	225	mcd	I_F=20mA
S2	225	285		
T1	285	360		
T2	360	450		
U1	450	565		

Bin Range of Dominant Wavelength

Group	Bin Code	Min.	Max.	Unit	Condition
F	FF1	621	626	nm	I_F=20mA
	FF2	626	631		

Bin Rang of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
B	0	1.75	1.95	V	I_F=20mA
	1	1.95	2.15		
	2	2.15	2.35		

Notes:

1.Tolerance of Luminous Intensity: ±11%
2.Tolerance of Dominant Wavelength: ±1nm
3.Tolerance of Forward Voltage: ±0.1V

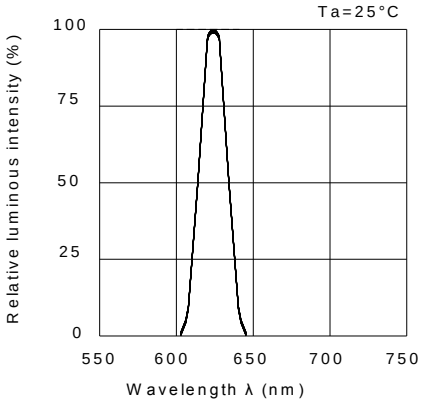
Technical Data Sheet -Preliminary

Top View LEDs

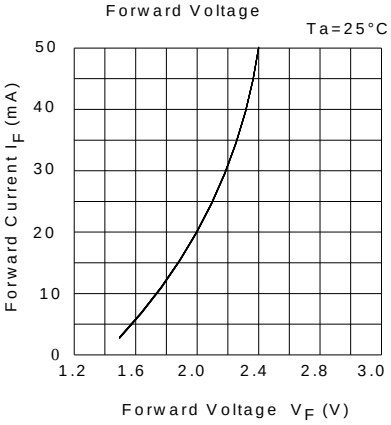
67-21/R6C-FS1U1B/2T

Typical Electro-Optical Characteristics Curves

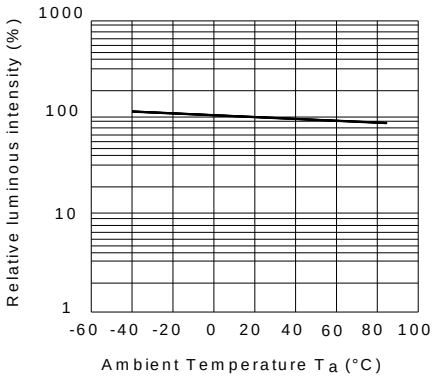
Spectrum Distribution



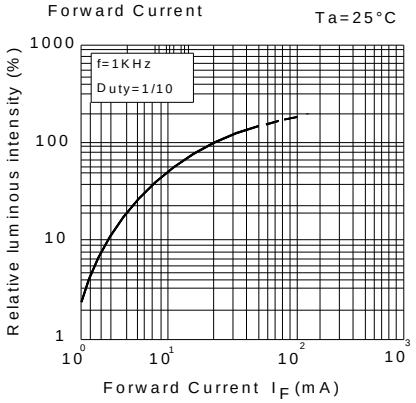
Forward Current vs. Forward Voltage



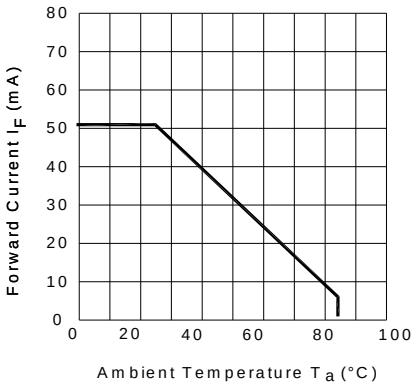
Relative Luminous Intensity vs. Ambient Temperature



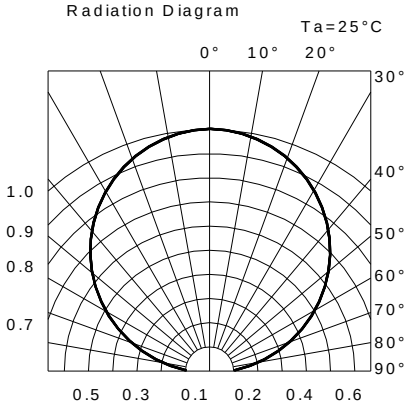
Relative Luminous Intensity vs. Forward Current



Forward Current Derating Curve



Radiation Diagram



Technical Data Sheet -Preliminary

Top View LEDs

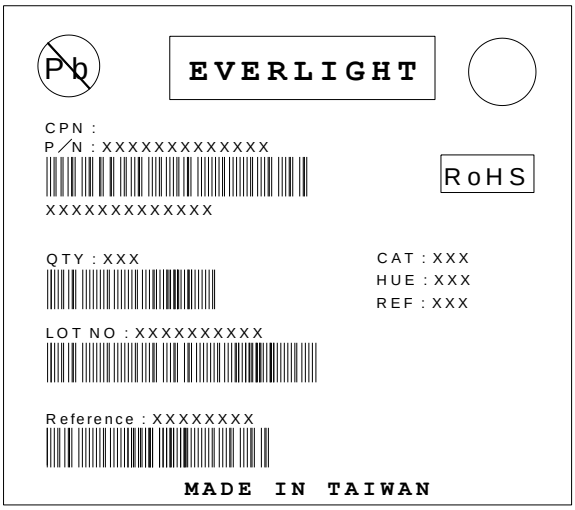
67-21/R6C-FS1U1B/2T

Label Explanation

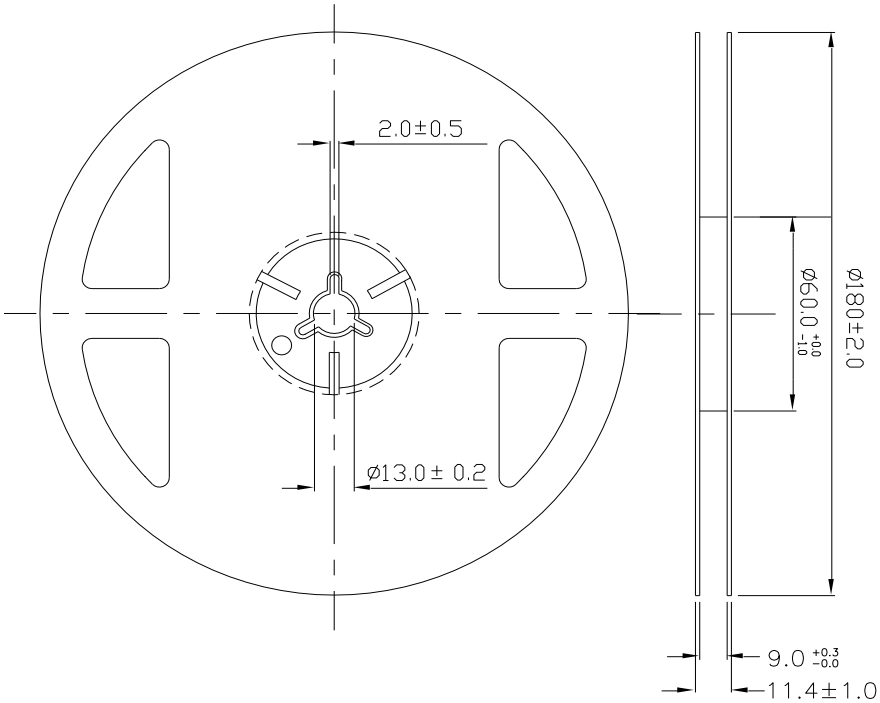
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



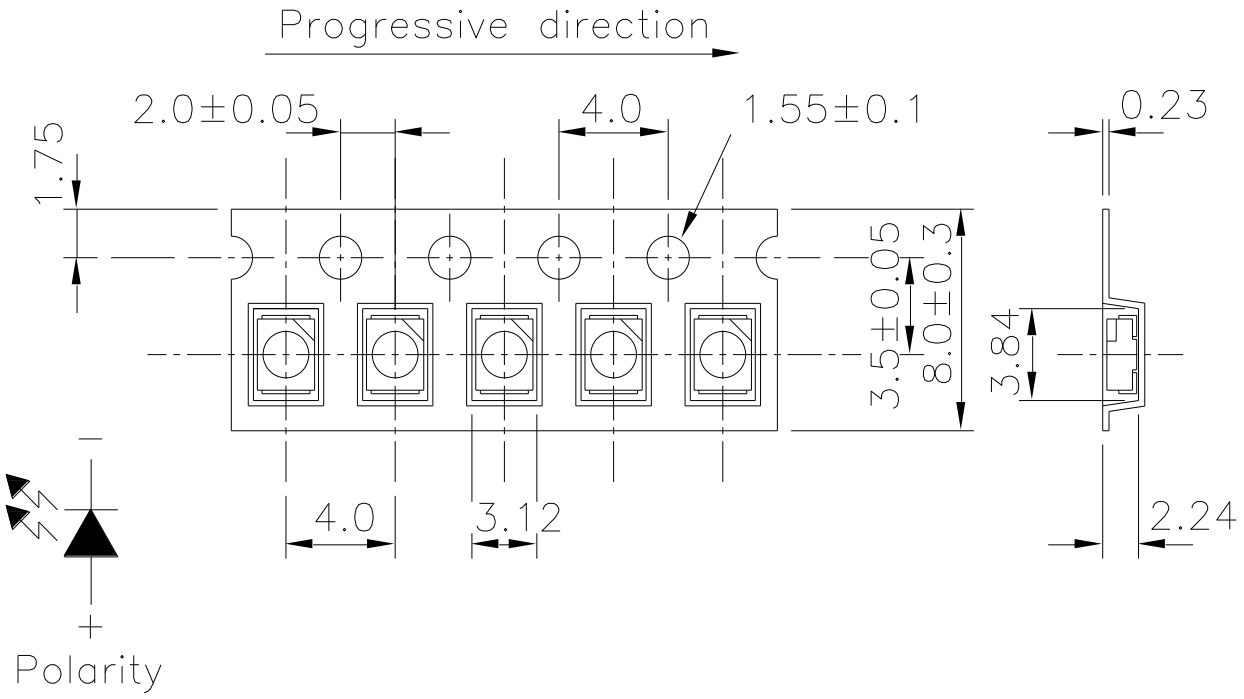
Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

Technical Data Sheet -Preliminary

Top View LEDs

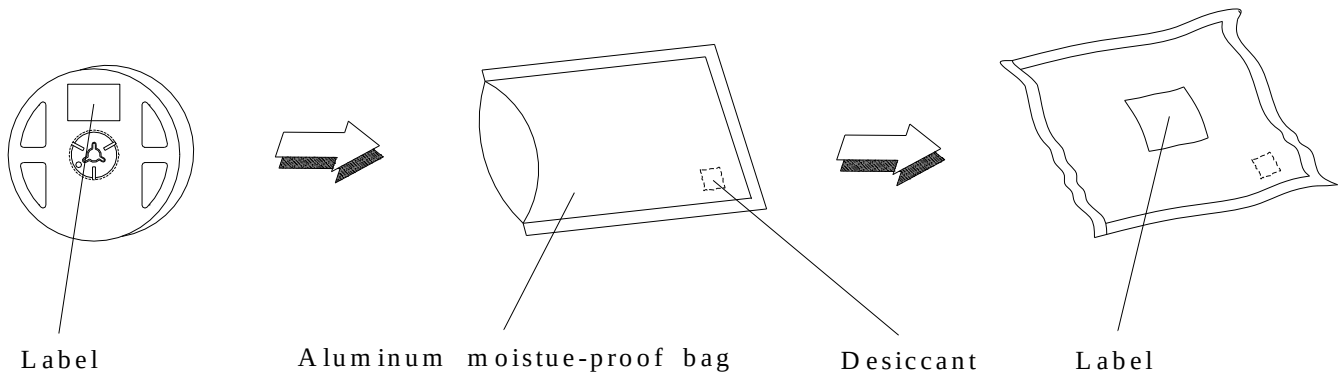
67-21/R6C-FS1U1B/2T

Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel.



Note: The tolerances unless mentioned is ±0.1mm Unit = mm

Moisture Resistant Packaging



Technical Data Sheet -Preliminary

Top View LEDs

67-21/R6C-FS1U1B/2T

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.
Confidence level：90%
LTPD：10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260℃±5℃ Min. 10 sec.	6 Min.	22 PCS	0/1
2	Temperature Cycle	H : +100℃ 15min ∫ 5 min L : -40℃ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100℃ 5min ∫ 10 sec L : -10℃ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I_F = 20 mA / 25℃	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/85%RH	1000 Hrs.	22 PCS.	0/1

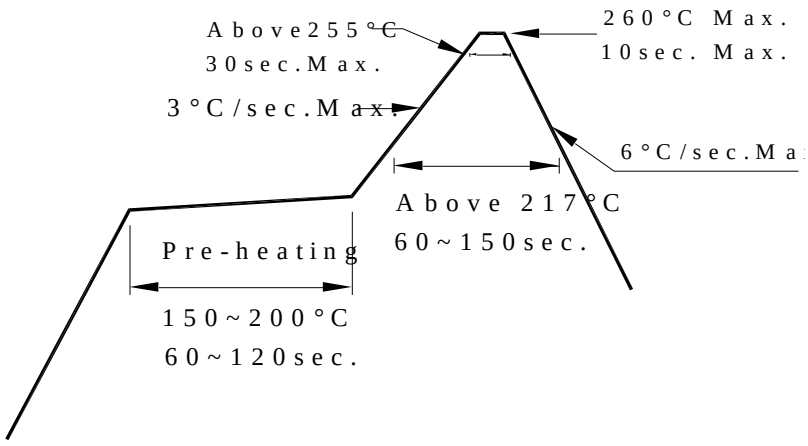
Technical Data Sheet -Preliminary

Top View LEDs

67-21/R6C-FS1U1B/2T

Precautions For Use

1. Over-current-proof
   Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).
2. Storage
   2.1 Do not open moisture proof bag before the products are ready to use.
   2.2 Before opening the package: The LEDs should be kept at 30℃ or less and 90%RH or less.
   2.3 After opening the package: The LED's floor life is 168 hours under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
   2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
   Baking treatment : 60±5℃ for 24 hours.
3. Soldering Condition
   3.1 Pb-free solder temperature profile



.
   3.2 Reflow soldering should not be done more than two times.
   3.3 When soldering, do not put stress on the LEDs during heating.
   3.4 After soldering, do not warp the circuit board.

Technical Data Sheet -Preliminary

Top View LEDs

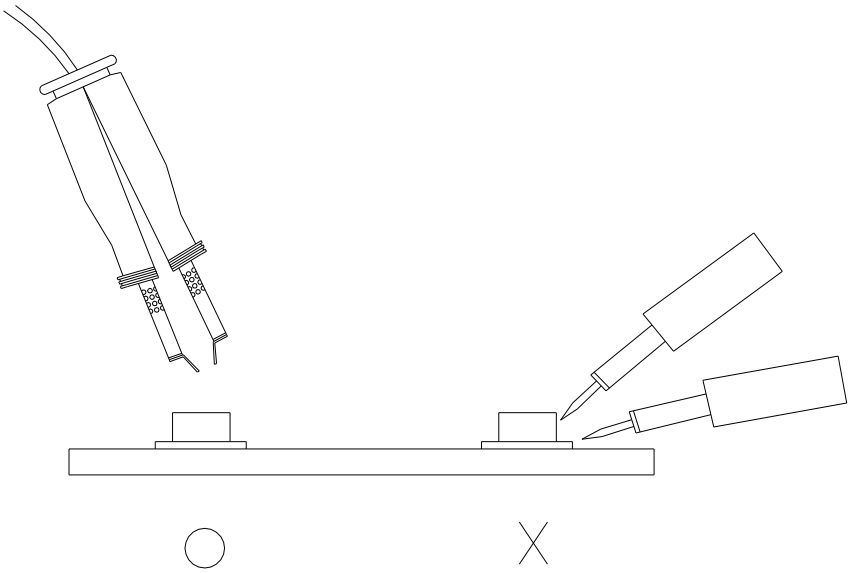
67-21/R6C-FS1U1B/2T

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.
Office: No 25, Lane 76, Sec 3, Chung Yang Rd,
Tucheng, Taipei 236, Taiwan, R.O.C
Tel: 886-2-2267-2000, 2267-9936
Fax: 886-2267-6244, 2267-6189, 2267-6306
http://www.everlight.com